International
IOR Rectifier

IRIS-G6353

INTEGRATED SWITCHER

Features

• Oscillator is provided on the monolithic control with adopting On-Chip-Trimming technology.

• Small temperature characteristics variation by adopting a comparator to compensate for temperature on the control part.

• Low start-up circuit current (100uA max)

• Built-in Active Low-Pass Filter for stabilizing the operation in case of light load

• Avalanche energy guaranteed MOSFET with high VDSS

• The built-in power MOSFET simplifies the surge absorption circuit since the MOSFET guarantees the avalanche energy.

• No VDSS de-rating is required.

• Built-in constant voltage drive circuit

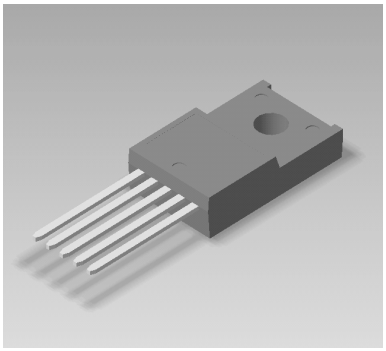
•Various kinds of protection functions

• Pulse-by-pulse Overcurrent Protection (OCP)

• Overvoltage Protection with latch mode (OVP)

• Thermal Shutdown with latch mode (TSD)

Package Outline



TO-220 Fullpack (5 Lead)

Key Specifications

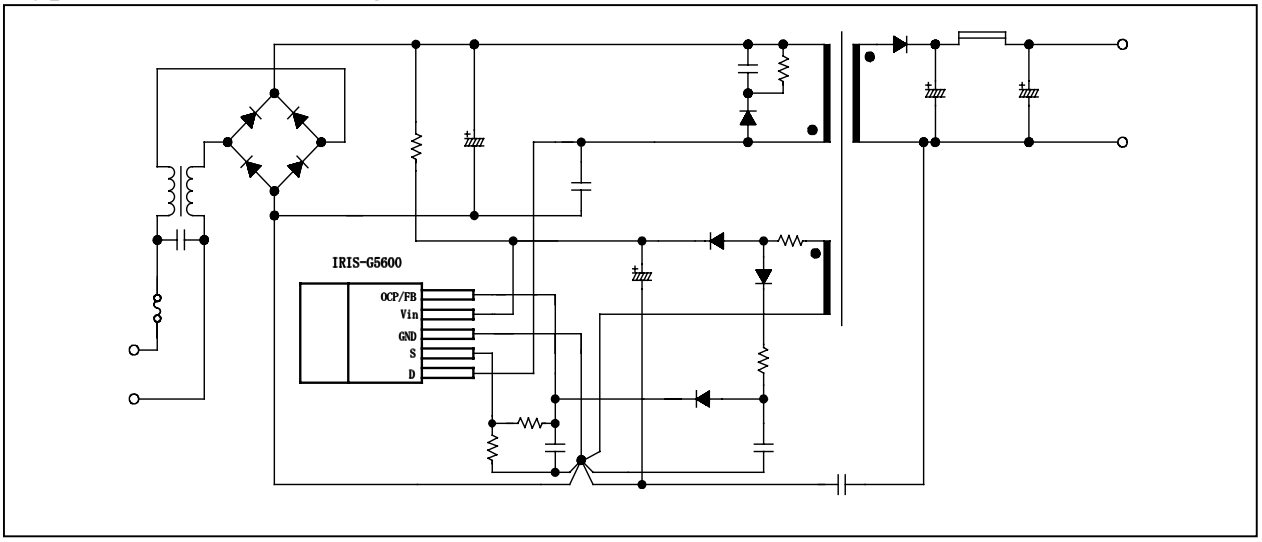
Type	MOSFET VDSS(V)	RDS(ON) MAX	AC input(V)	Pout(W) Note 1
IRIS-G6353	650	1.90Ω	230±15%	120
			85 to 264	58

Descriptions

IRIS-G6353 is a hybrid IC consists from power MOSFET and a controller IC, designed for Indirect feed-back Quasi-Resonant (including low frequency PRC) fly-back converter type SMPS (Switching Mode Power Supply) applications. This IC realizes high efficiency, low noise, downsizing and standardizing of a power supply system reducing external components count and simplifying the circuit designs.

(Note). PRC is abbreviation of "Pulse Ratio Control" (On-width control with fixed OFF-time).

Typical Connection Diagram



Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to terminals stated, all currents are defined positive into any lead. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Terminals	Max. Ratings	Units	Note
I_{Dpeak}	Drain Current *1	1-2	10	A	Single Pulse
I_{DMAX}	Maximum switching current *5	1-2	10	A	V_{2-3}=0.82V Ta=-20~+125℃
E_{AS}	Single pulse avalanche energy *2	1-2	125	mJ	Single Pulse V_{DD}=99V, L=20mH $I_{L\,peak}$=3.2A
Vin	Input voltage for control part	4-3	35	V	
Vth	O.C.P/F.B Pin voltage	5-3	6	V	
P_{D1}	Power dissipation for MOSFET *3	1-2	26	W	With infintite heatsink
			1.5	W	Without heatsink
P_{D2}	Power dissipation for control part (Control IC) *4	4-3	0.8	W	Specified by Vin×Iin
T_F	Internal frame temperature in operation	-	-20 ~ +125	℃	Refer to recommended operating temperature
Top	Operating ambient temperature	-	-20 ~ +125	℃	
Tstg	Storage temperature	-	-40 ~ +125	℃	
Tch	Channel temperature	-	150	℃	

*1 Refer to MOS FET A.S.O curve

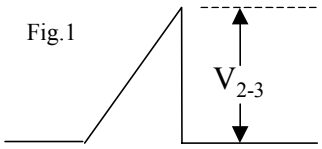
*2 MOS FET Tch-EAS curve

*3 Refer to MOS FET Ta-PD1 curve

*4 Refer to TF-PD2 curve for Control IC (See page 5)

*5 Maximum switching current.

Fig.1



The maximum switching current is the Drain current determined by the drive voltage of the IC and threshold voltage (Vth) of MOS FET. Therefore, in the event that voltage drop occurs between Pin 2 and Pin 3 due to patterning, the maximum switching current decreases as shown by V_{2-3} in Fig.1 Accordingly please use this device within the decrease value, referring to the derating curve of the maximum switching current.

Electrical Characteristics (for Control IC)

Electrical characteristics for control part (Ta=25℃, Vin=18V,unless otherwise specified)

Symbol	Definition	Ratings			Units	Test Conditions
		MIN	TYP	MAX		
$V_{in(ON)}$	Operation start voltage	15.8	17.6	19.4	V	Vin=0→19.4V
$V_{in(OFF)}$	Operation stop voltage *6	9.1	10.1	11.1	V	Vin=19.4→9.1V
$I_{in(ON)}$	Circuit current in operation	-	-	5	mA	-
$I_{in(OFF)}$	Circuit current in non-operation	-	-	50	μA	Vin=15V
$T_{OFF(MAX)}$	Maximum OFF time	12	15	18	μsec	-
Vth	O.C.P/F.B Pin threshold voltage	0.7	0.76	0.82	V	-
$I_{OCP/FB}$	O.C.P/F.B Pin extraction current	0.7	0.8	0.9	mA	-
$V_{in(OVP)}$	O.V.P operation voltage	23.2	25.5	27.8	V	Vin=0→27.8V
$I_{in(H)}$	Latch circuit sustaining current *7	-	-	70	μA	Vin=27.8→(Vin(OFF)-0.3)V
$V_{in(La.OFF)}$	Latch circuit release voltage *6,7	7.9	-	10.5	V	Vin=27.8→7.9V
$T_{j(TSD)}$	Thermal shutdown operating temperature	135	-	-	℃	-

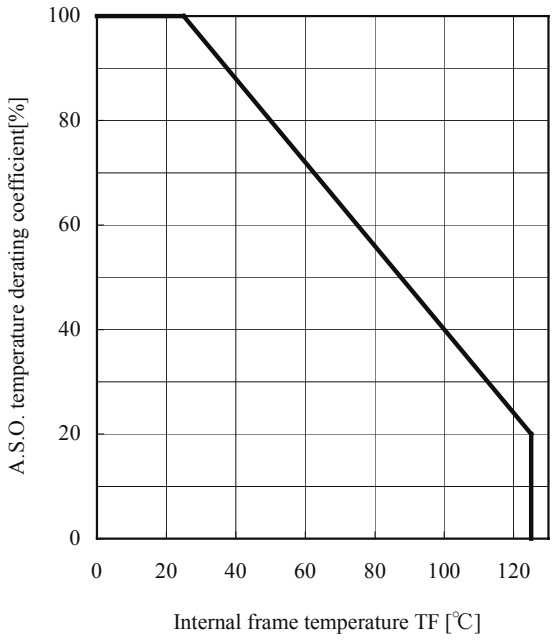
*6 The relation of $V_{IN(OFF)} > V_{IN(La.OFF)}$ is applied for each product
*7 The latch circuit means a circuit operated O.V.P and T.S.D.

Electrical Characteristics (for MOSFET)

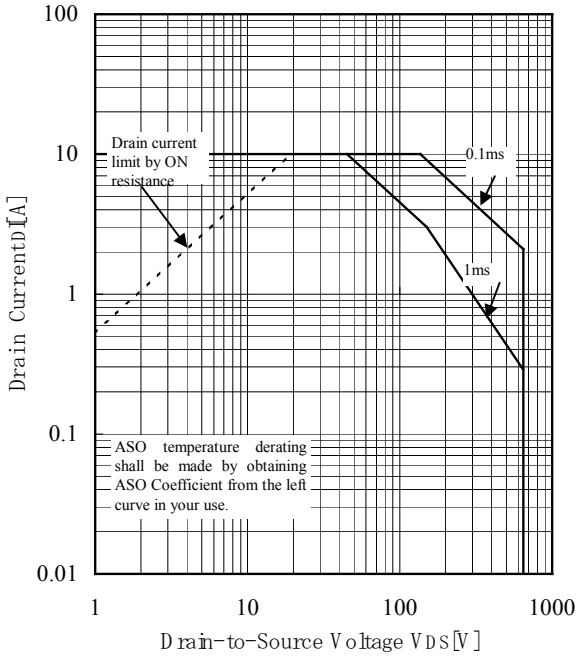
(Ta=25℃) unless otherwise specified

Symbol	Definition	Ratings			Units	Test Conditions
		MIN	TYP	MAX		
V_{DSS}	Drain-to-Source breakdown voltage	650	-	-	V	ID=300μA V3-2=0V(short)
I_{DSS}	Drain leakage current	-	-	300	μA	VDS=650V V3-2=0V(short)
$R_{DS(ON)}$	On-resistance	-	-	1.9	Ω	V3-2=10V ID=1.2A
tf	Switching time	-	-	250	nsec	-
θ_{ch-F}	Thermal resistance	-	-	2	℃/W	Between channel and internal frame

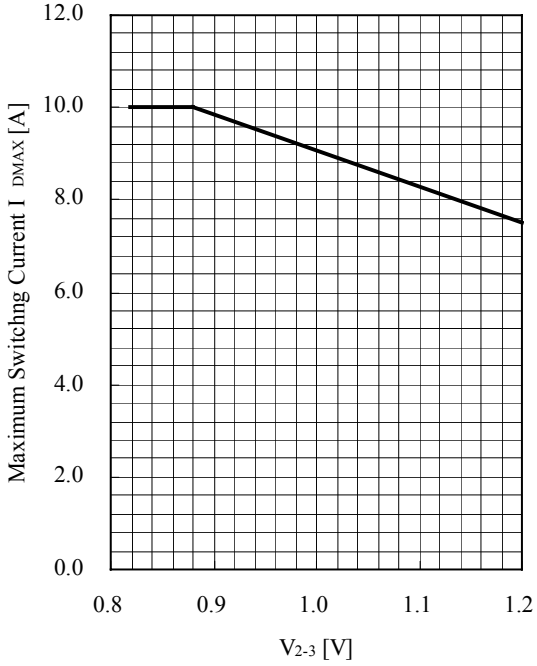
IRIS-G6353
A.S.O. temperature derating coefficient curve



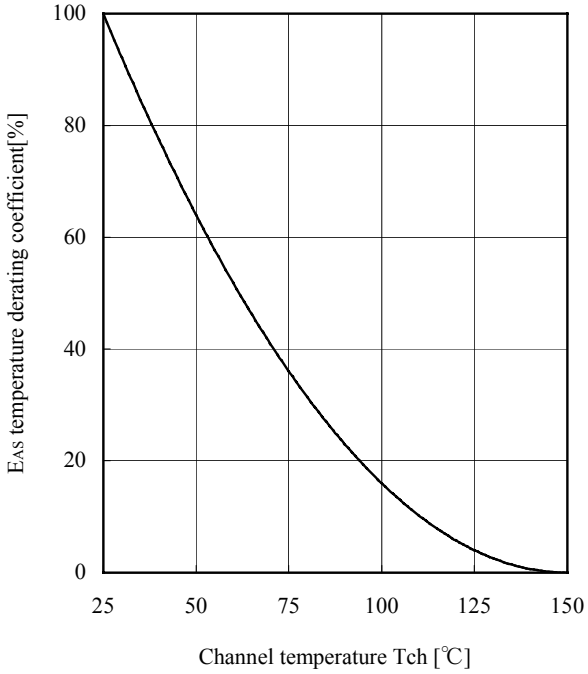
IRIS-G6353
MOSFET A.S.O. Curve



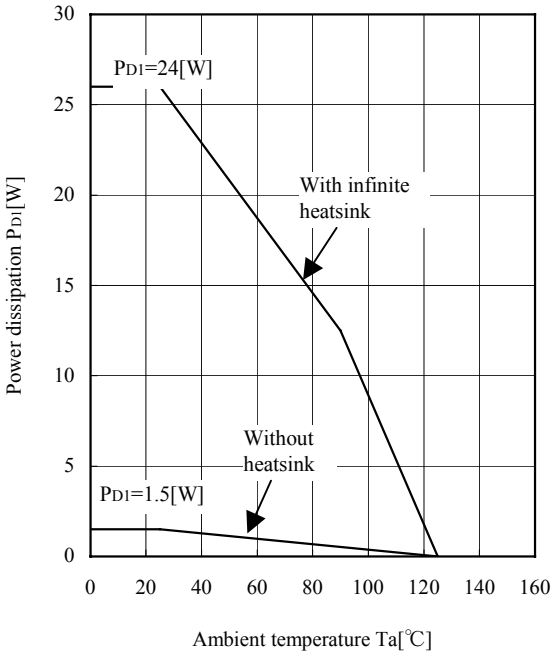
IRIS-G6353
Maximum Switching current derating curve
Ta= -20～+125℃



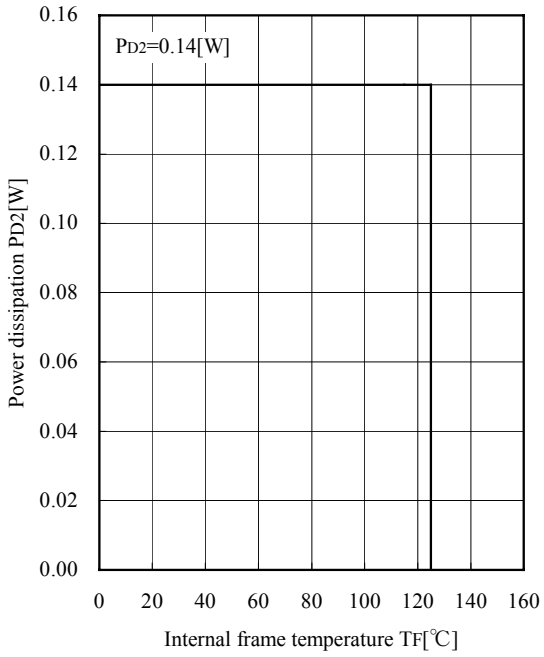
IRIS-G6353
Avalanche energy derating curve



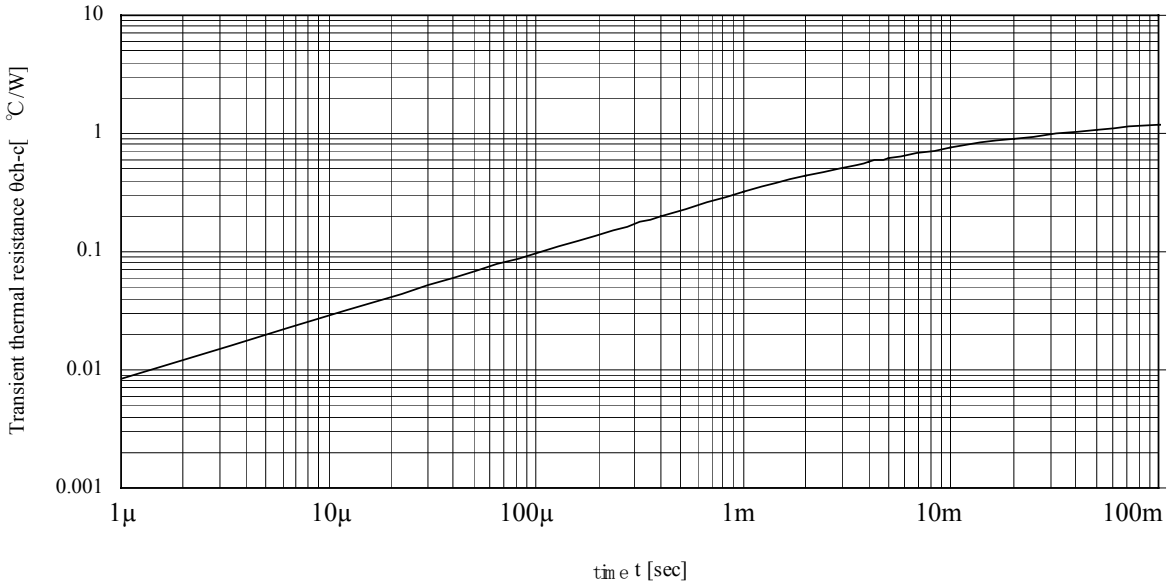
IRIS-G6353
MOSFET Ta-P_{D1} Curve



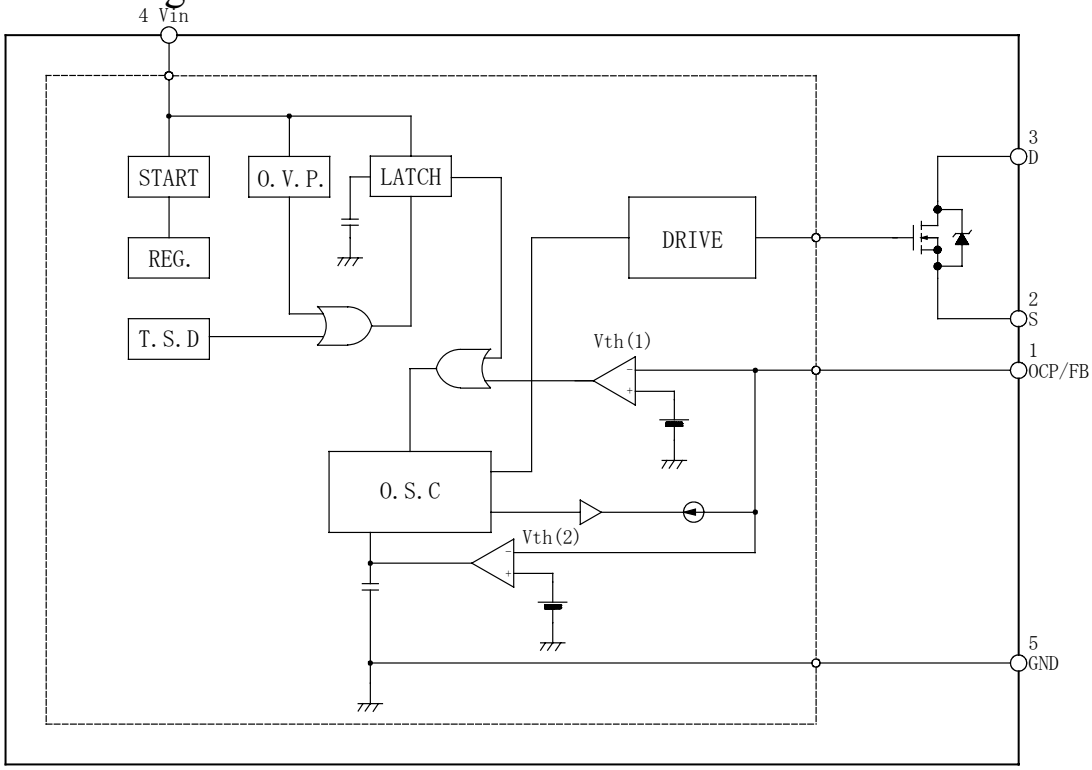
IRIS-G6353
MIC TF-PD2 Curve



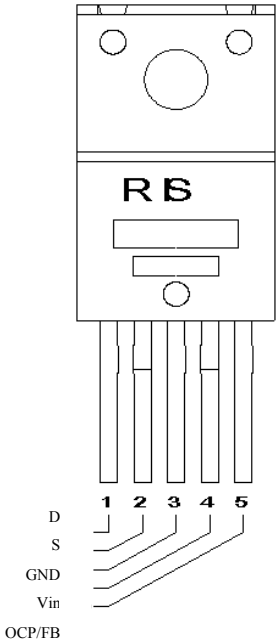
IRIS-G6353
Transient thermal resistance curve



Block Diagram



Lead Assignments



Pin No.	Symbol	Description	Function
1	D	Drain Pin	MOSFET drain
2	S	Source Pin	MOSFET source
3	GND	Ground Pin	Ground
4	Vin	Power supply Pin	Input of power supply for control circuit
5	OCP/FB	Overcurrent / Feedback Pin	Input of overcurrent detection signal / constant voltage control signal

Other Functions

O.V.P. – Overvoltage Protection Circuit

T.S.D. – Thermal Shutdown Circuit

SD – Step drive circuit

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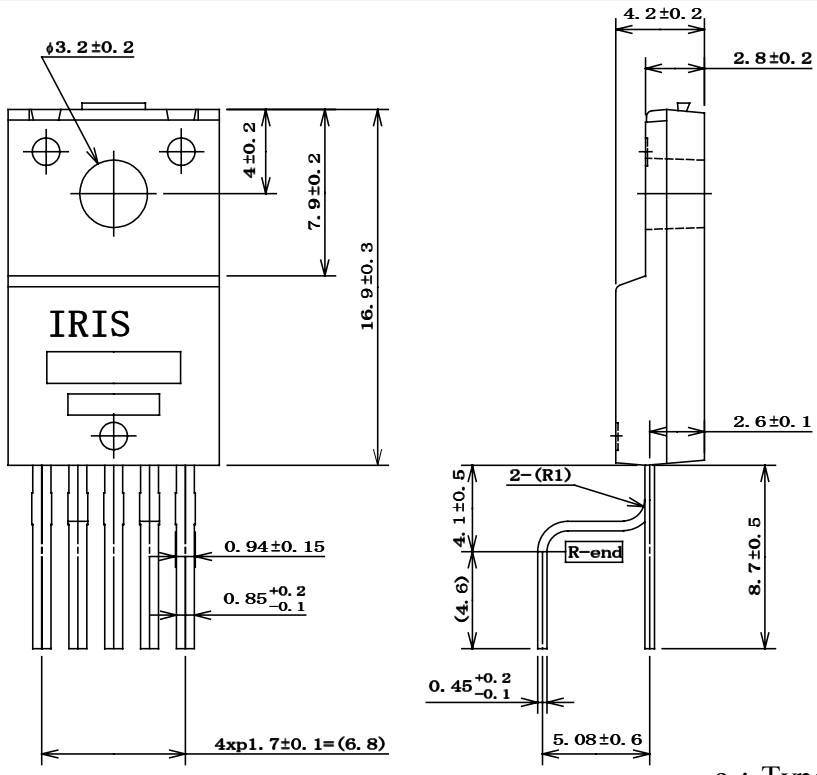
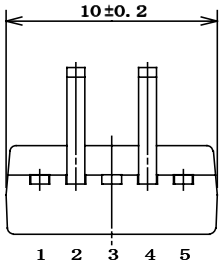
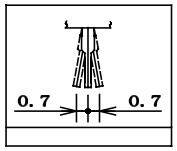
Case Outline







a : Type Number G6353
b : Lot Number
1st letter : The last digit of year
2nd letter : Month
1 to 9 for Jan. to Sept.,
O for Oct. N for Nov. D for Dec.
3rd & 4th letter : Day
Arabic Numerals

Weight : Approx. 2.3g
Dimensions in mm
DWG.No. : TG3A-1128

Material of Pin : Cu
Treatment of Pin : Ni plating + solder dip

Data and specifications subject to change without notice.

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